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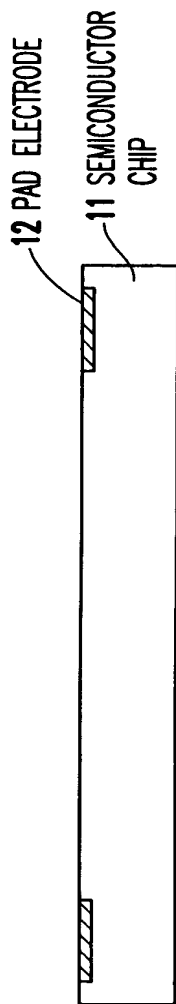


FIG. 2A
PRIOR ART

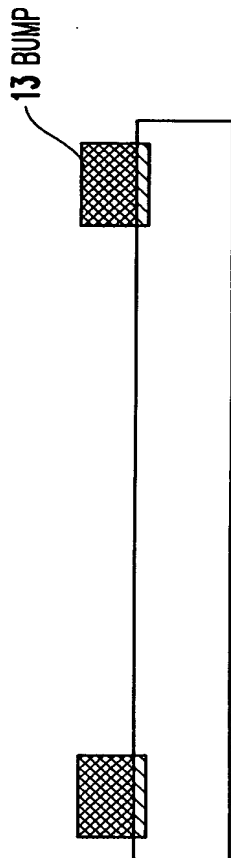


FIG. 2B
PRIOR ART

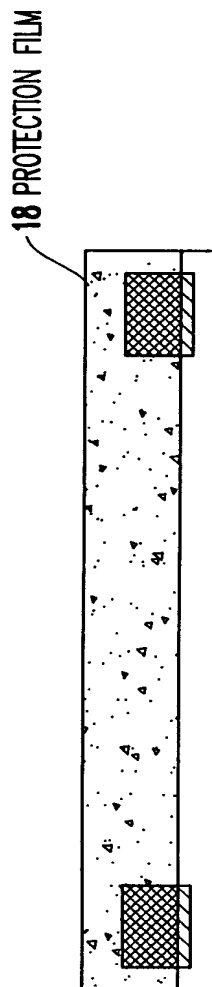


FIG. 2C
PRIOR ART



FIG. 2D
PRIOR ART



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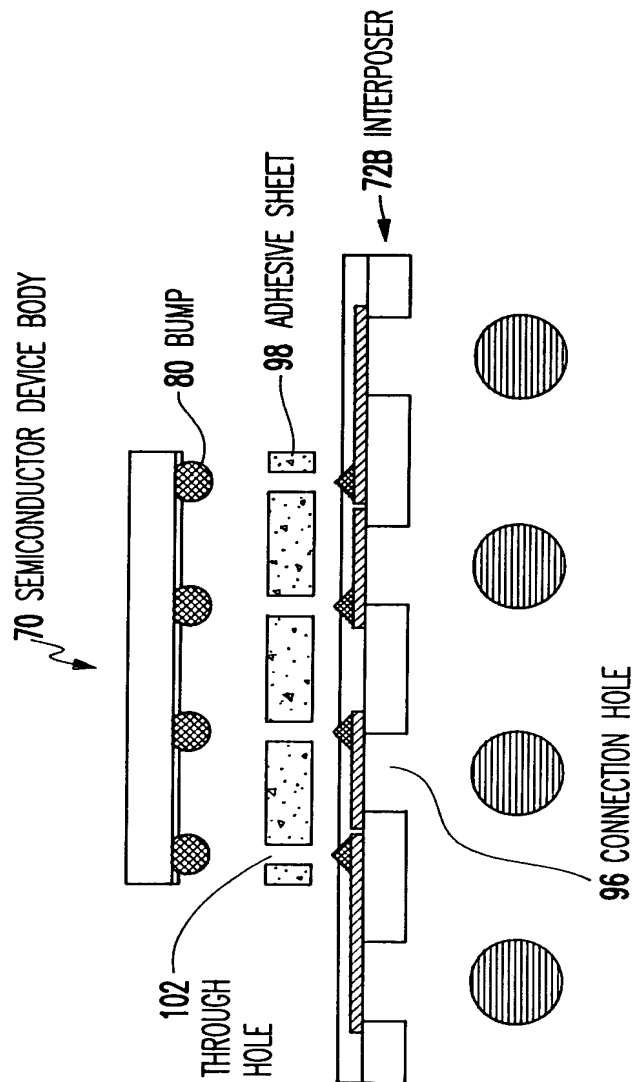


FIG.3
PRIOR ART

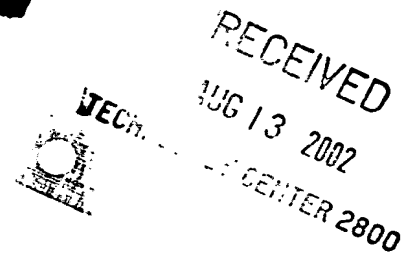


FIG.4A

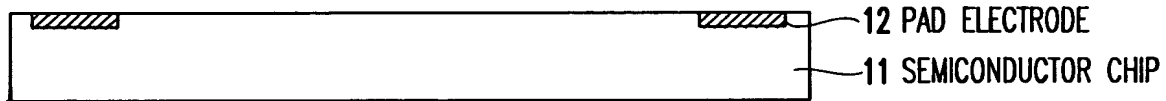


FIG.4B

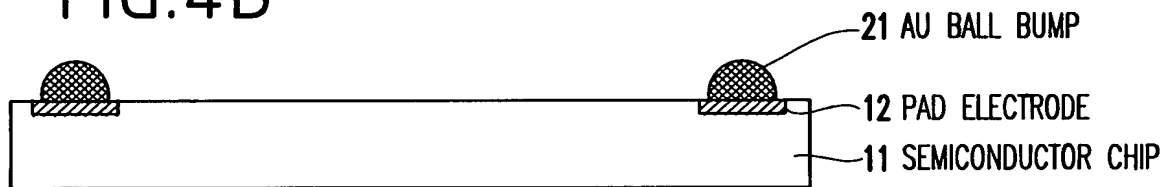


FIG.4C

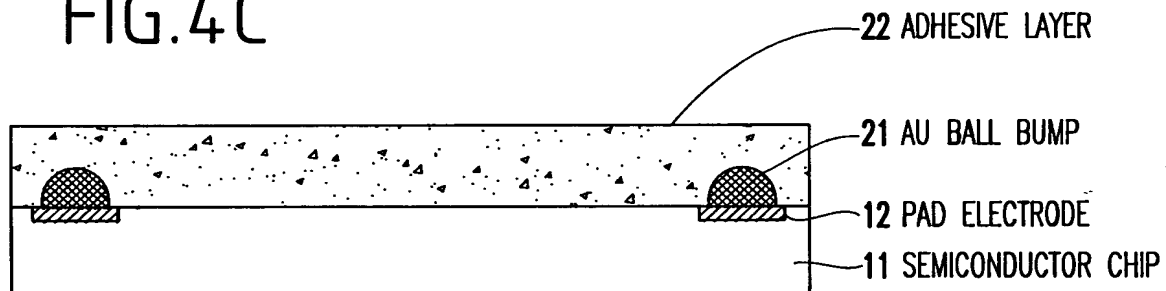
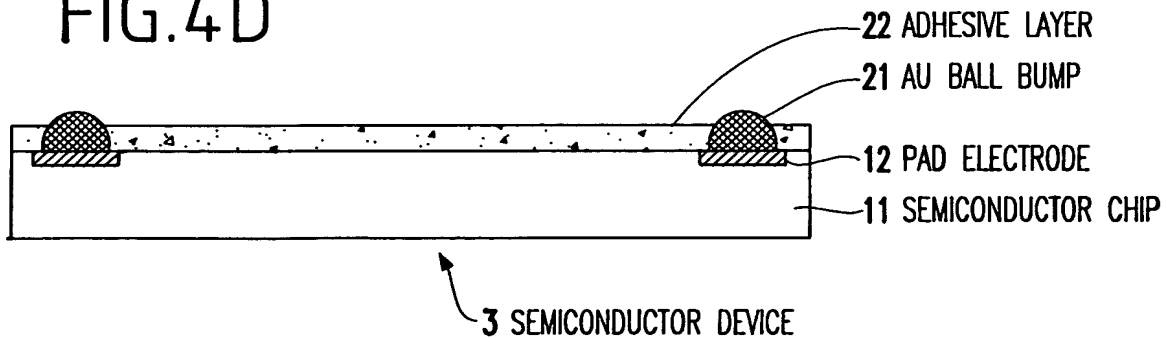


FIG.4D



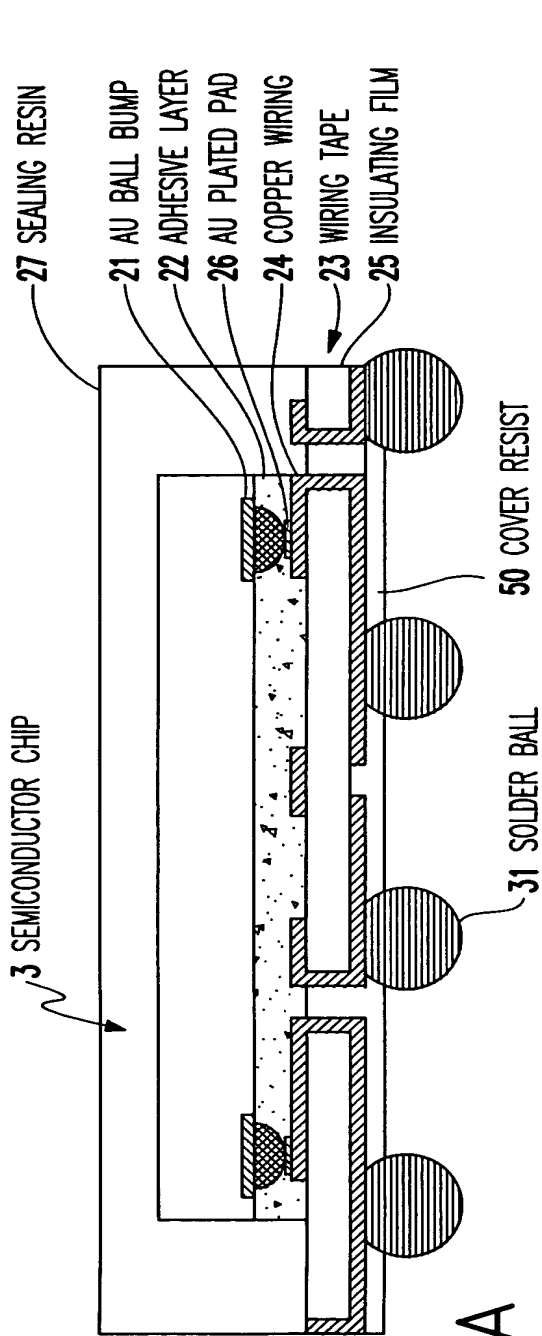


FIG. 5A

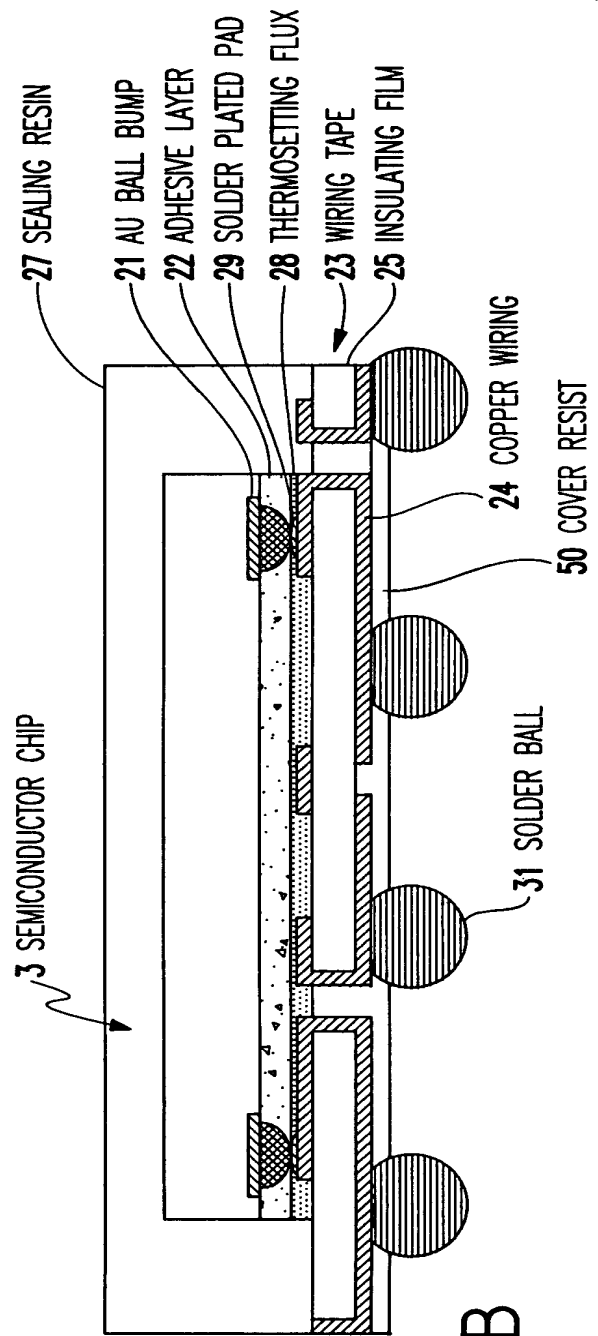


FIG. 5B

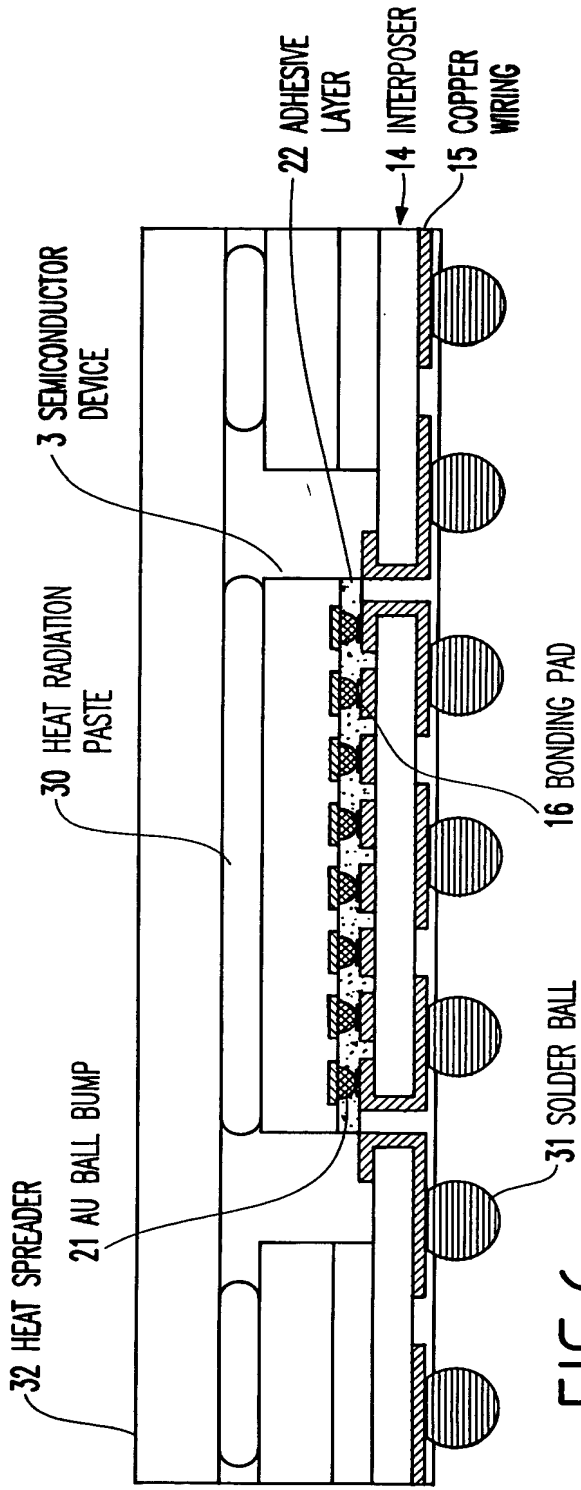


FIG. 6

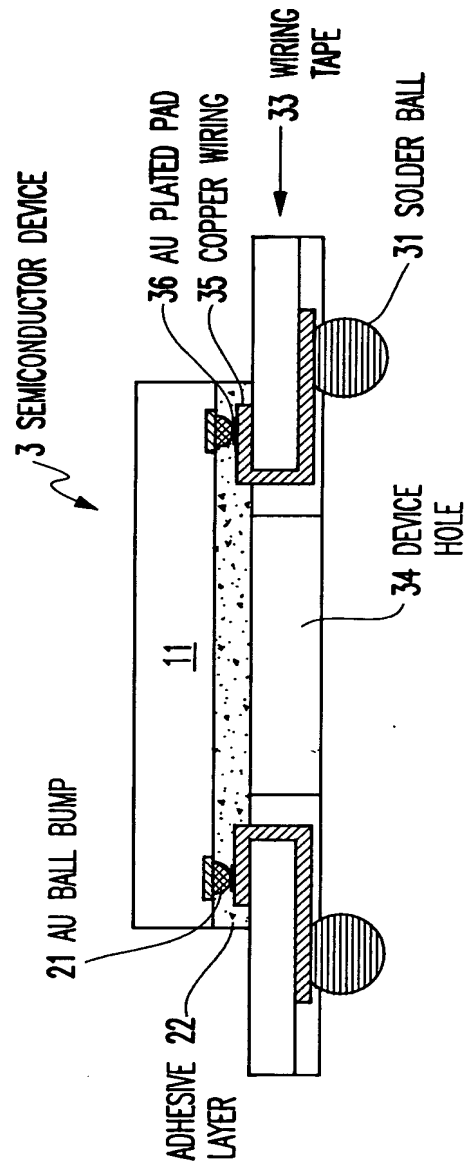


FIG. 7

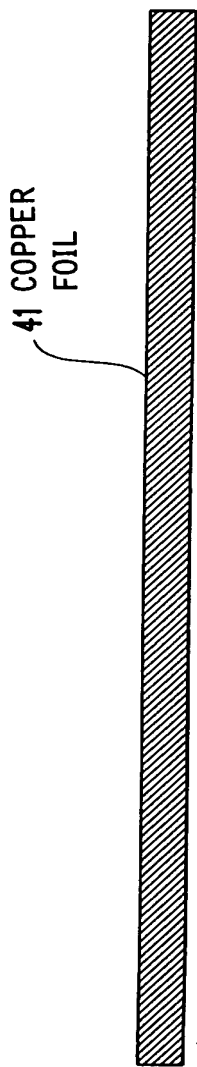


FIG. 8A

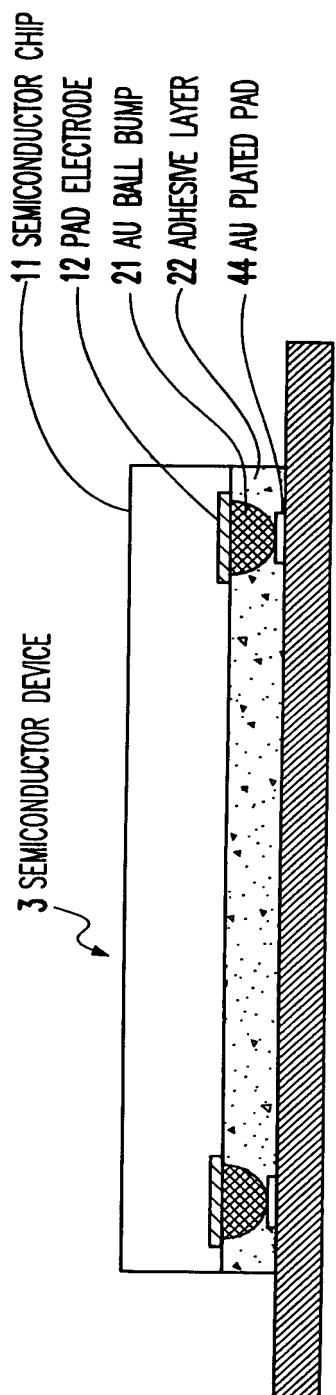


FIG. 8B

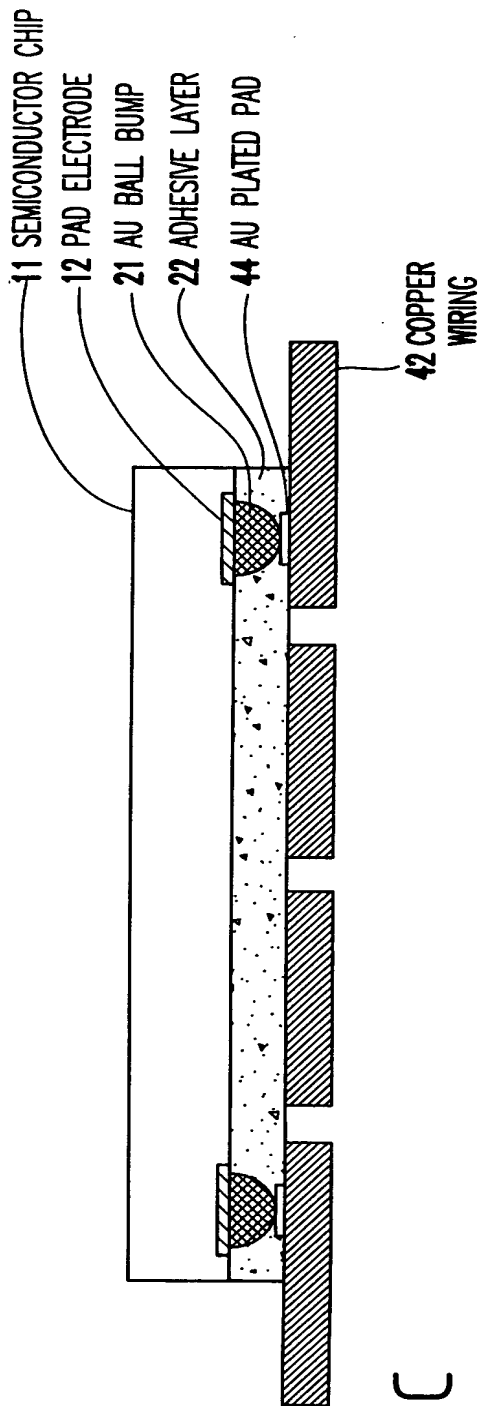


FIG. 8C

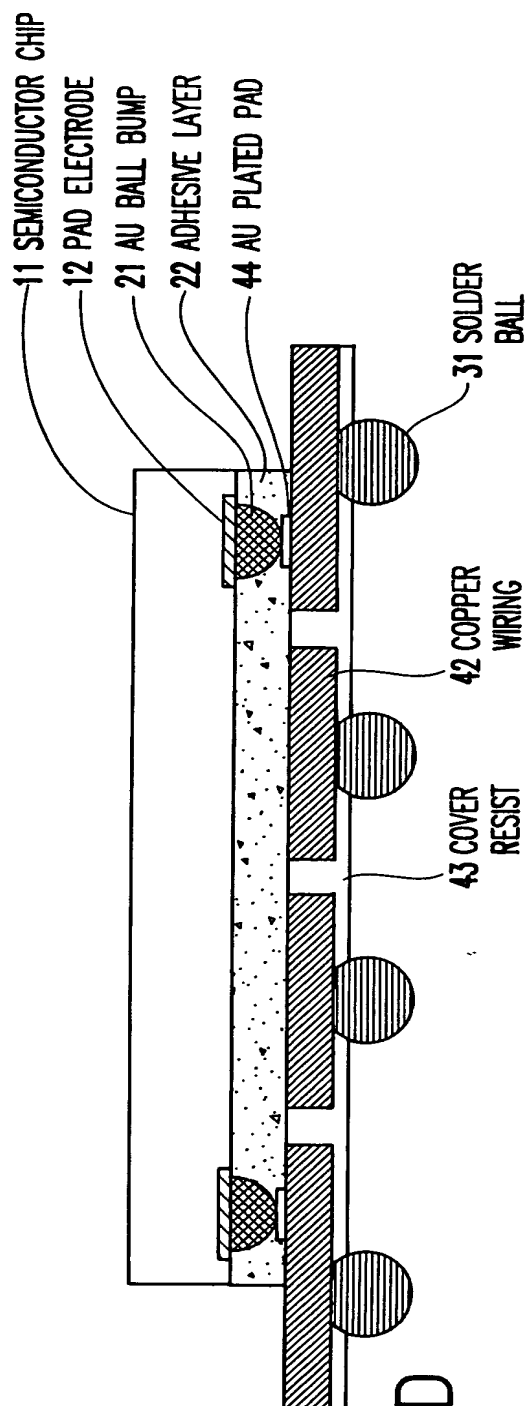


FIG. 8D

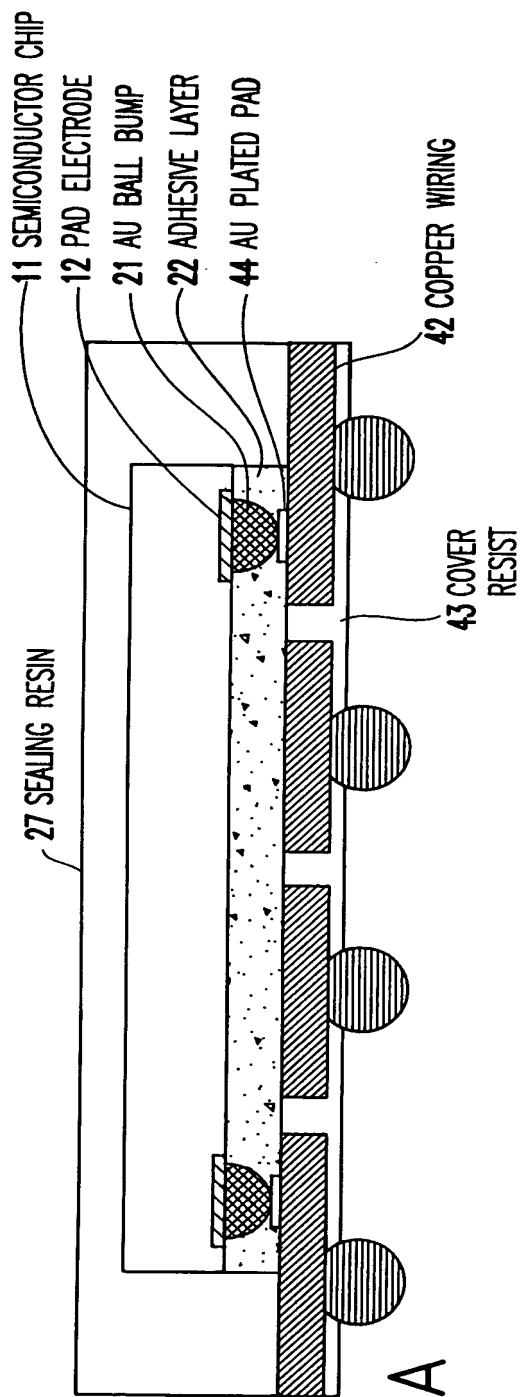


FIG. 9A

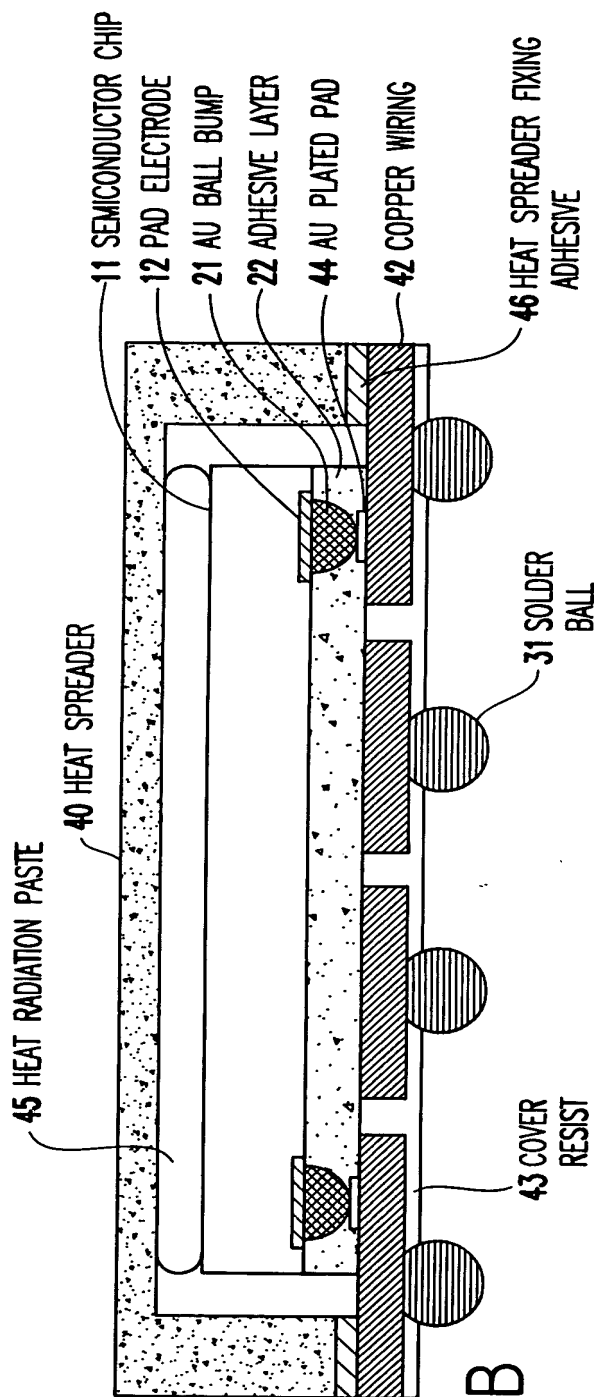


FIG. 9B

FIG. 10A

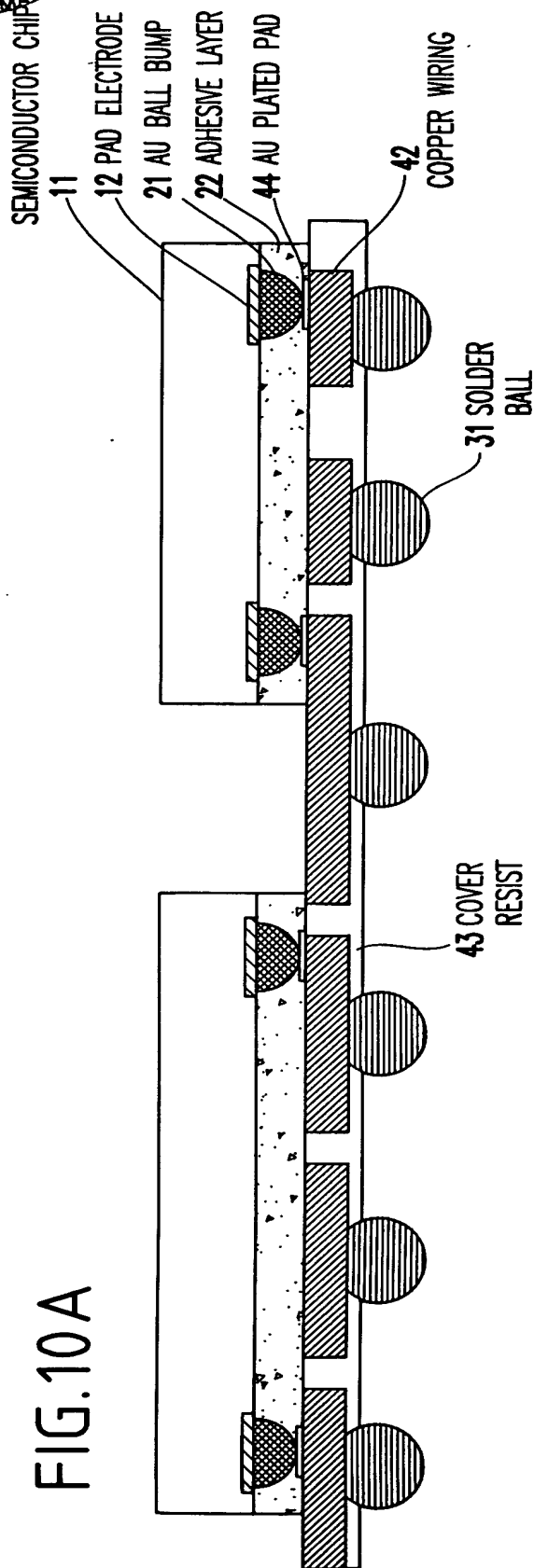
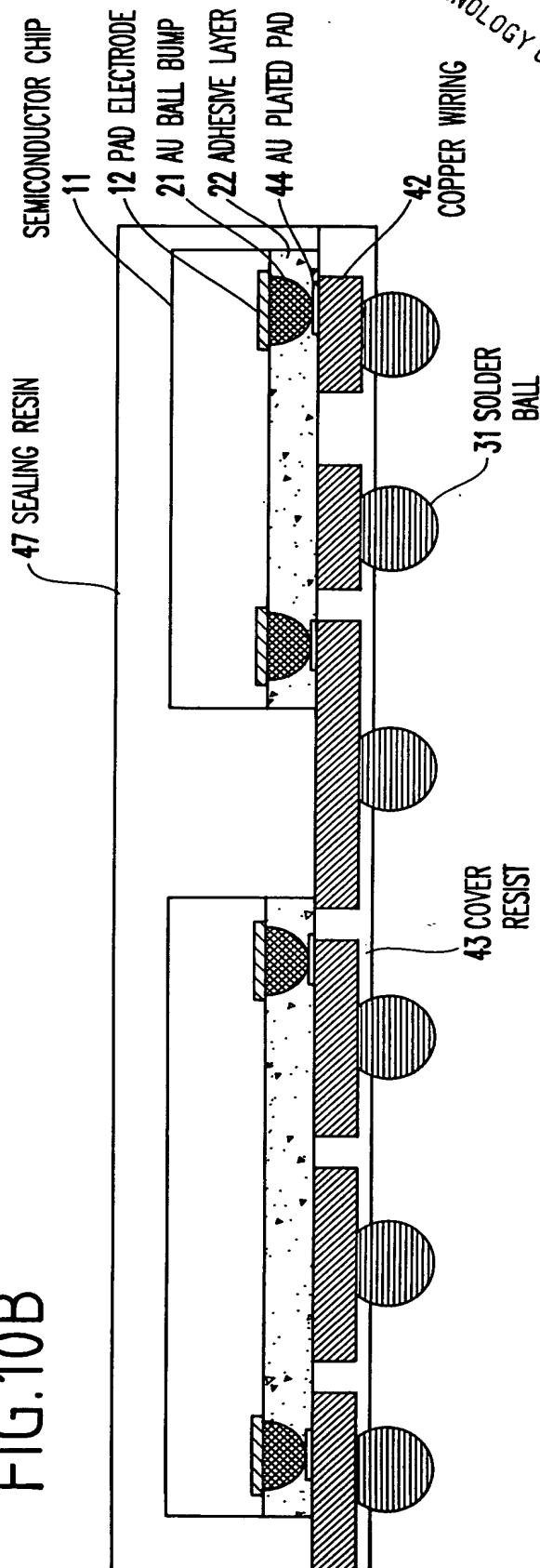


FIG. 10B



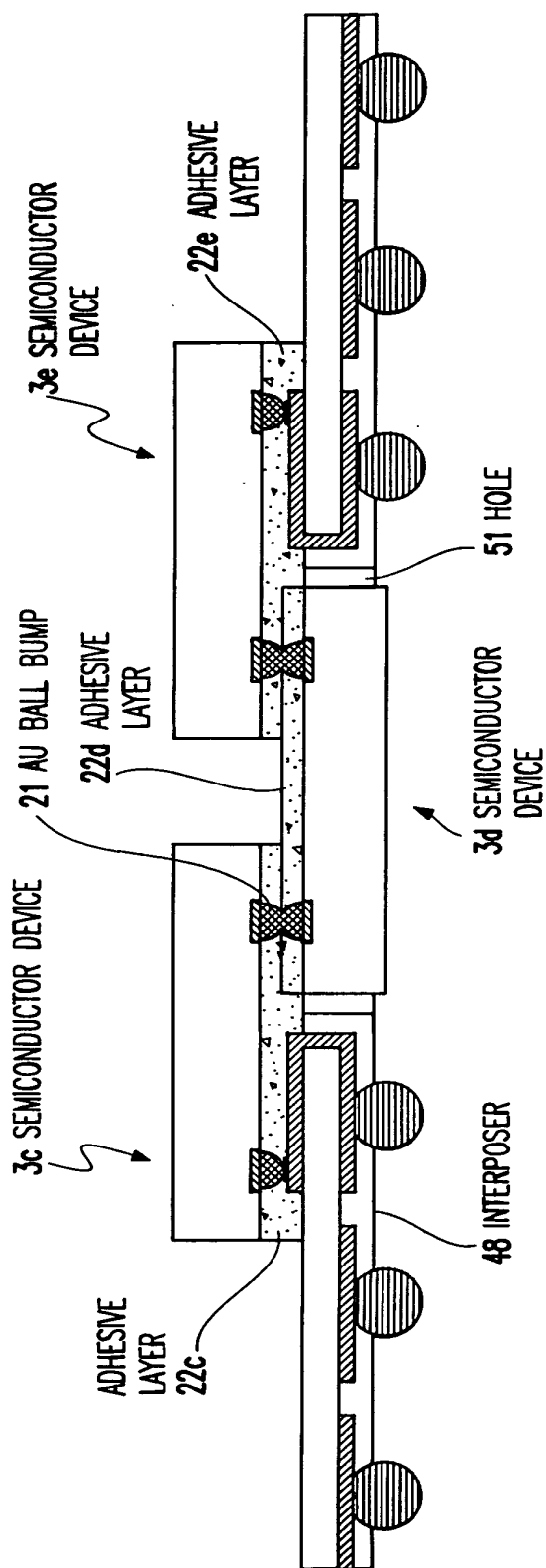


FIG. 11A

FIG. 11C

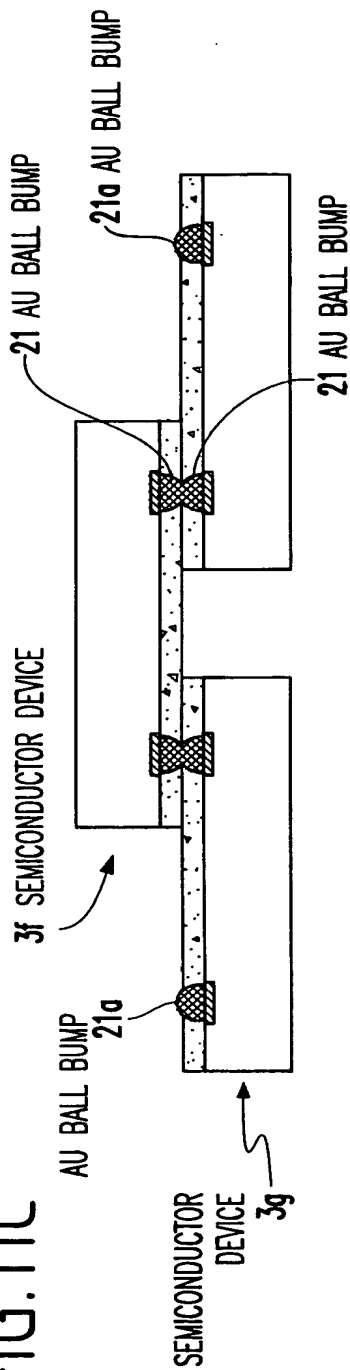
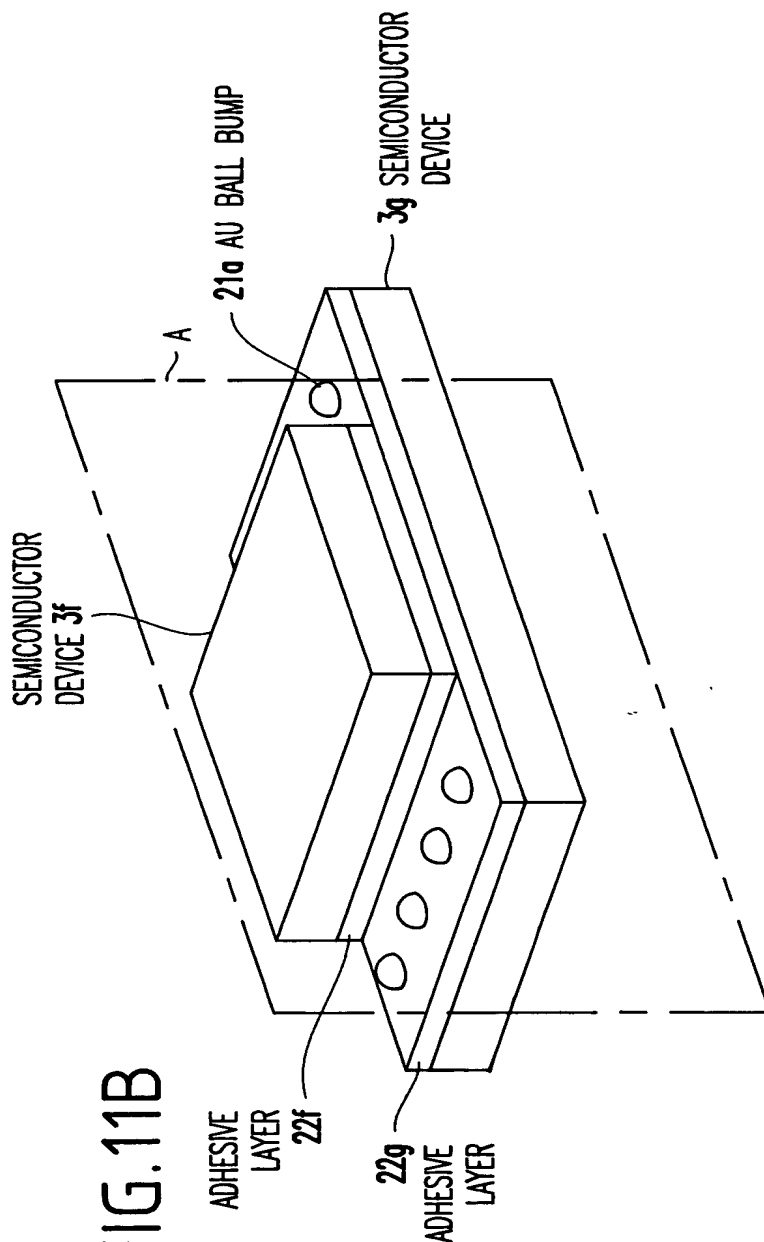


FIG. 11B



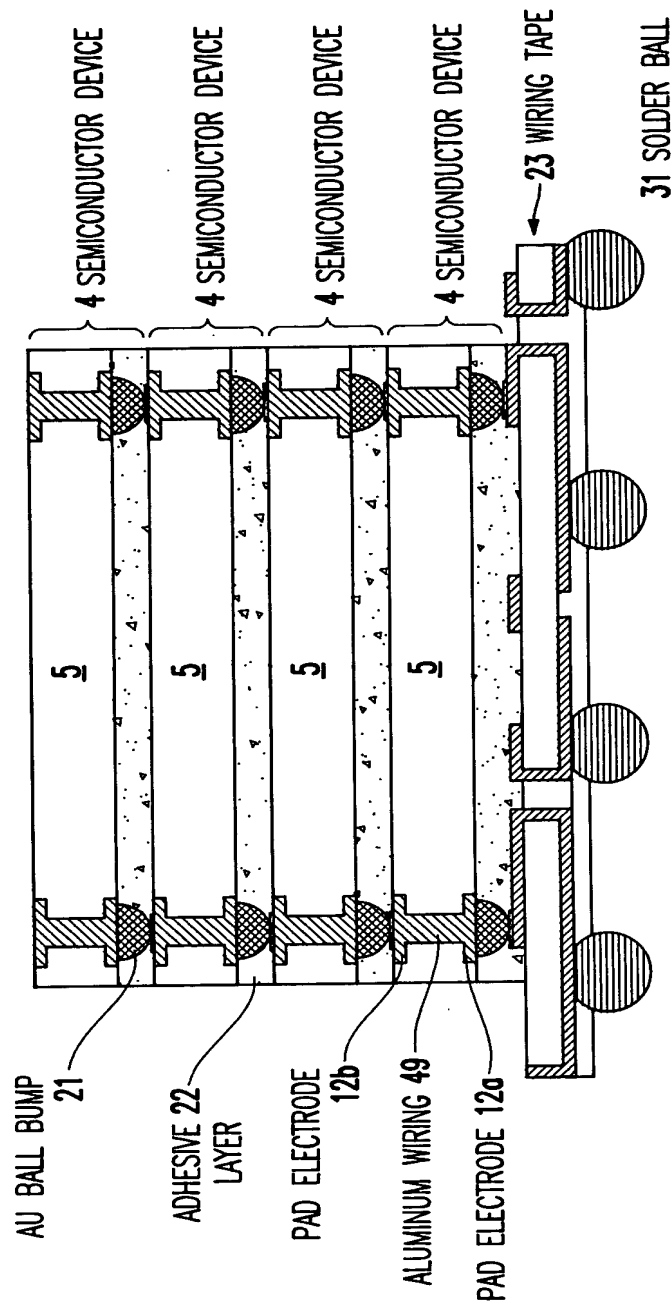


FIG.12

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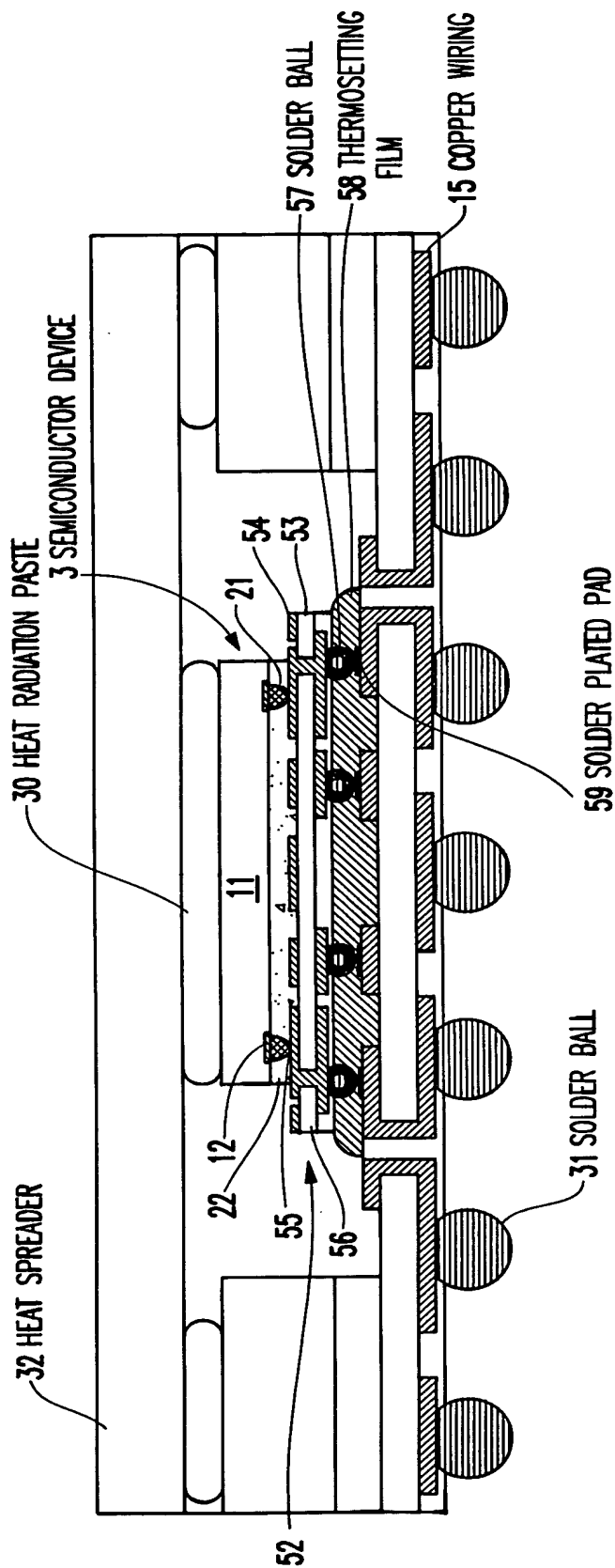


FIG. 13